# Universal Hexadecimal Counter

#### Description

The MC10H136 is a high speed synchronous hexadecimal counter. This 10H part is a functional/pinout duplication of the standard MECL  $10K^{TM}$  family part, with 100% improvement in counting frequency and no increase in power-supply current.

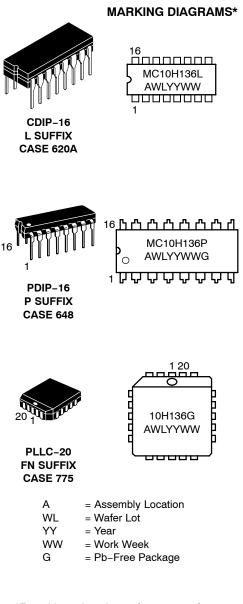
#### Features

- Counting Frequency, 250 MHz Minimum
- Power Dissipation, 625 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K Compatible
- Pb-Free Packages are Available\*



## **ON Semiconductor®**

http://onsemi.com



\*For additional marking information, refer to Application Note AND8002/D.

### ORDERING INFORMATION

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

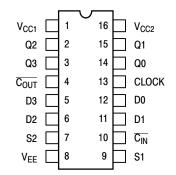
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## Table 1. FUNCTION SELECT TABLE

	• • • •		
CIN	S1	S2	Operating Mode
Х	L	L	Preset (Program)
L	L	Н	Increment (Count Up)
Н	L	Н	Hold Count
L	Н	L	Decrement (Count Down)
Н	Н	L	Hold Count
X	Н	Н	Hold (Stop Count)

#### Table 2. SEQUENTIAL TRUTH TABLE\*

	INPUTS					OUTPUTS						
S1	S2	D0	D1	D2	D3	Carry In	Clock * *	Q0	Q1	Q2	Q3	Carry Out
L	L	L	L	н	н	Х	н	L	L	н	н	L
L	н	Х	Х	х	х	L	Н	н	L	н	н	н
L	н	Х	Х	х	х	L	Н	L	н	н	н	н
L	н	х	Х	Х	Х	L	н	н	н	н	н	L
L	Н	Х	Х	Х	Х	Н	L	Н	н	Н	Н	Н
L	н	Х	Х	х	х	н	Н	н	н	н	н	н
н	н	Х	Х	х	х	Х	Н	н	н	н	н	н
L	L	Н	Н	L	L	Х	Н	н	Н	L	L	L
н	L	Х	Х	Х	Х	L	Н	L	н	L	L	Н
н	L	Х	Х	Х	Х	L	н	н	L	L	L	н
н	L	Х	Х	Х	Х	L	н	L	L	L	L	L
н	L	Х	Х	Х	Х	L	Н	н	Н	Н	Н	Н



Pin assignment is for Dual-in-Line Package.

### Figure 1. Pin Assignment

\* Truth table shows logic states assuming inputs vary in sequence shown from top to bottom. \*\* A clock H is defined as a clock input transition from a low to a high logic level.

#### Table 3. MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
$V_{EE}$	Power Supply (V <sub>CC</sub> = 0)	-8.0 to 0	Vdc
VI	Input Voltage (V <sub>CC</sub> = 0)	0 to V <sub>EE</sub>	Vdc
l <sub>out</sub>	Output Current – Continuous – Surge	50 100	mA
T <sub>A</sub>	Operating Temperature Range	0 to +75	°C
T <sub>stg</sub>	Storage Temperature Range – Plastic – Ceramic	–55 to +150 −55 to +165	°C ℃

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

		(	)°	25°		<b>75</b> °		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
Ι <sub>Ε</sub>	Power Supply Current	-	165	-	150	-	165	mA
I <sub>inH</sub>	Input Current High		100		075		075	μΑ
	Pins 5, 6, 11, 12, 13 Pin 9	-	430 670	-	275 420	-	275 420	
	Pin 7 Pin 10	-	535 380	-	335 240	-	335 240	
I <sub>inL</sub>	Input Current Low	0.5	-	0.5	-	0.3	-	μA
V <sub>OH</sub>	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V <sub>OL</sub>	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
V <sub>IH</sub>	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
VIL	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

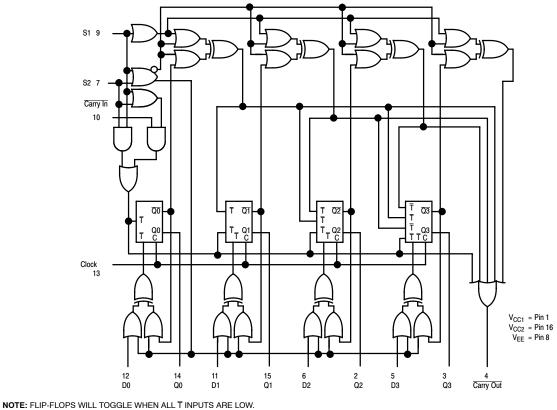
## Table 4. ELECTRICAL CHARACTERISTICS (V<sub>EE</sub> = -5.2 V $\pm 5\%$ ) (Note 1)

1. Each MECL 10H<sup>™</sup> series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50 Ω resistor to −2.0 V.

#### Table 5. AC CHARACTERISTICS

		0	o	25	5°	7	75°	
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
t <sub>pd</sub>	Propagation Delay							ns
	Clock to Q	0.7	2.3	0.7	2.4	0.7	2.5	
	Clock to Carry Out	1.0	4.8	1.0	4.9	1.0	5.0	
	Carry in to Carry							
	Out	0.7	2.5	0.7	2.6	0.7	2.7	
t <sub>set</sub>	Set-up Time							ns
	Data (D0 to C)	2.0	-	2.0	-	2.0	-	
	Select (S to C)	3.5	-	3.5	-	3.5	-	
	Carry In (C <sub>in</sub> to C)	2.0	-	2.0	-	2.0	-	
	(C to C <sub>in</sub> )	0	-	0	-	0	-	
t <sub>hold</sub>	Hold Time							ns
	Data (C to D0)	0	-	0	-	0	-	
	Select (C to S)	-0.5	-	-0.5	-	-0.5	-	
	Carry In (C to C <sub>in</sub> )	0	-	0	-	0	-	
	(C <sub>in</sub> to C)	2.2	-	2.2	-	2.2	-	
f <sub>count</sub>	Counting Frequency	250	-	250	-	250	-	MHz
t <sub>r</sub>	Rise Time	0.5	2.3	0.5	2.4	0.5	2.5	ns
t <sub>f</sub>	Fall Time	0.5	2.3	0.5	2.4	0.5	2.5	ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.



JPS WILL TOGGLE WHEN ALL T INPUTS ARE LOW.

Figure 2. Logic Diagram

## **APPLICATION INFORMATION**

The MC10H136 is a high speed synchronous counter that operates at 250 MHz. Counter operating modes include count up, count down, pre-set and hold count. This device allows the designer to use one basic counter for many applications. The S1, S2, control lines determine the operating modes of the counter. In the pre-set mode, a clock pulse is necessary to load the counter with the information present on the data inputs (D0, D1, D2, and D3). Carry out goes low on the terminal count or when the counter is being pre-set.

#### **ORDERING INFORMATION**

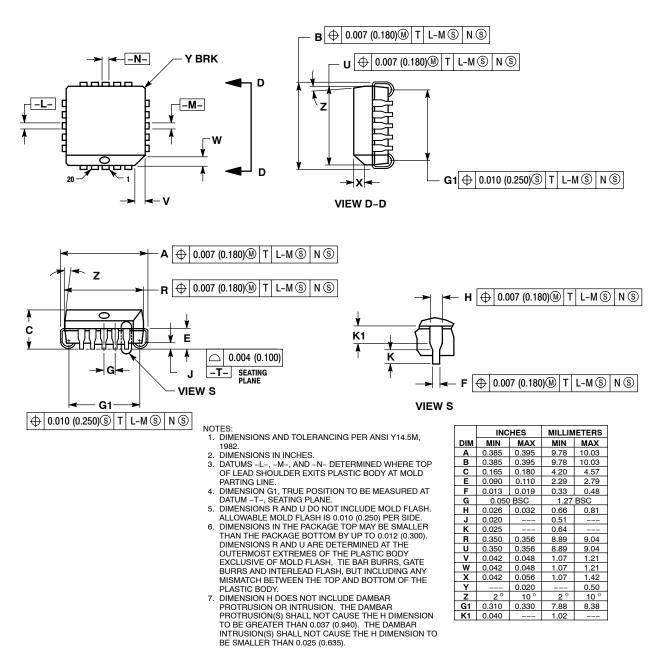
Device	Package	Shipping <sup>†</sup>
MC10H136FN	PLLC-20	46 Units / Rail
MC10H136FNG	PLLC-20 (Pb-Free)	46 Units / Rail
MC10H136FNR2	PLLC-20	500 / Tape & Reel
MC10H136FNR2G	PLLC-20 (Pb-Free)	500 / Tape & Reel
MC10H136L	CDIP-16	25 Unit / Rail
MC10H136P	PDIP-16	25 Unit / Rail
MC10H136PG	PDIP-16 (Pb-Free)	25 Unit / Rail

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

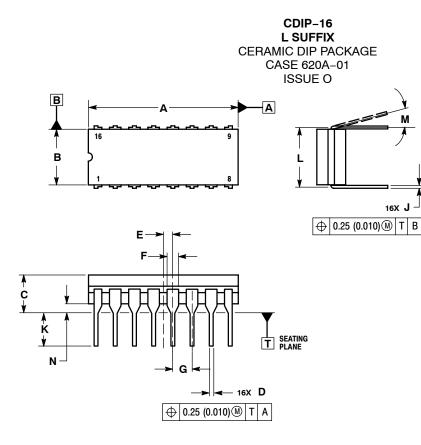
#### PACKAGE DIMENSIONS



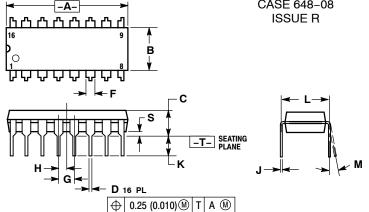
CASE 775-02 ISSUE E



### **PACKAGE DIMENSIONS**



PDIP-16 **P SUFFIX** PLASTIC DIP PACKAGE CASE 648-08



NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL. 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY

THIS DRAWING REPLACES OBSOLETE CASE OUTLINE 620-10. 5

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
Ε	0.050	BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300 BSC		7.62 BSC		
Μ	0 °	15 °	0 °	15°	
N	0.020	0.040	0.51	1.01	

NOTES:

- NOTES:

   1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

   2. CONTROLLING DIMENSION: INCH.

   3. DIMENSION LTO CENTER OF LEADS WHEN FORMED PARALLEL

   4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

   5. ROUNDED CORNERS OPTIONAL

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27 BSC		
J	0.008	0.015	0.21	0.38	
Κ	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
М	0°	10 °	0 °	10 °	
S	0.020	0.040	0.51	1.01	

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